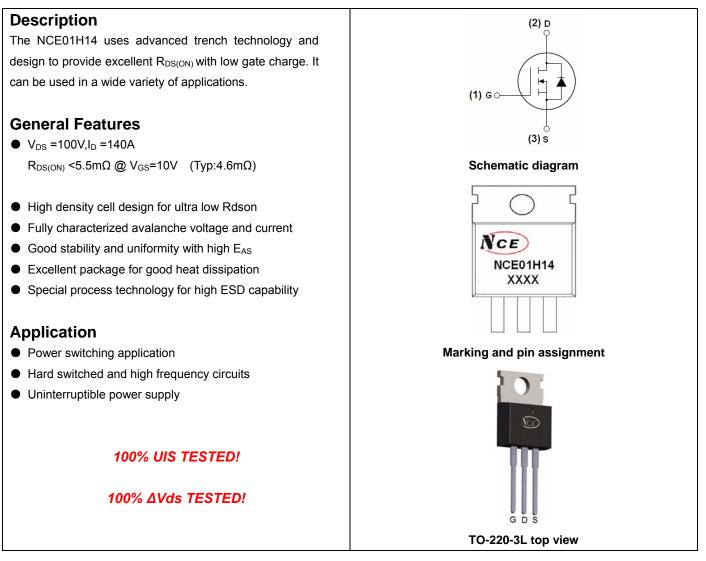


NCE01H14

NCE N-Channel Enhancement Mode Power MOSFET



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE01H14	NCE01H14	TO-220-3L	-	-	-

Absolute Maximum Ratings (T_c=25[°]C unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	Vds	100	V	
Gate-Source Voltage	Vgs	±20	V	
Drain Current-Continuous	Ι _D	140	Α	
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	97	А	
Pulsed Drain Current	I _{DM}	550	А	
Maximum Power Dissipation	PD	330	W	
Derating factor		2.2	W/°C	
Single pulse avalanche energy (Note 5)	E _{AS}	1200	mJ	



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Parameter	Symbol	Limit	Unit		
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C		
Thermal Characteristic					
Thermal Resistance, Junction-to-Case ^(Note 2)	R _{θJC}	0.45	°C/W		

Electrical Characteristics (T_c=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·					
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	100	110	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·					
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	2	3.2	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =40A	-	4.6	5.5	mΩ
Forward Transconductance	g fs	V _{DS} =50V,I _D =40A	170	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}		-	10500	-	PF
Output Capacitance	C _{oss}	$V_{DS}=25V, V_{GS}=0V,$	-	914	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	695	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	25	-	nS
Turn-on Rise Time	tr	V _{DD} =65V,I _D =40A	-	100	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{GEN} =2.5 Ω	-	65	-	nS
Turn-Off Fall Time	t _f		-	77	-	nS
Total Gate Charge	Qg		-	120	-	nC
Gate-Source Charge	Q _{gs}	$V_{DS}=44V, I_{D}=40A,$	-	30	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	35	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =40A	-	0.85	1.2	V
Diode Forward Current (Note 2)	Is		-	-	40	А
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 40A	-	45	70	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	80	120	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				y LS+LD)

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300 μ s, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition:Tj=25 $^\circ C$,V_DD=50V,V_G=10V,L=1mH,Rg=25\Omega

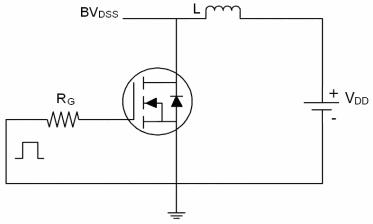


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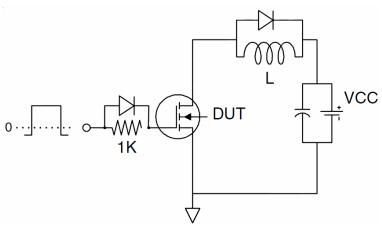




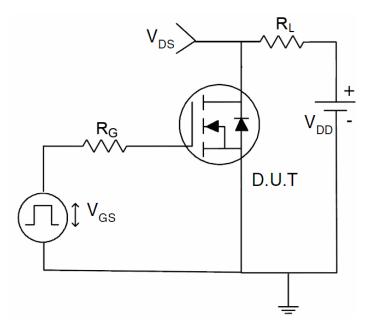
Test Circuit 1) E_{AS} test Circuit



2) Gate charge test Circuit



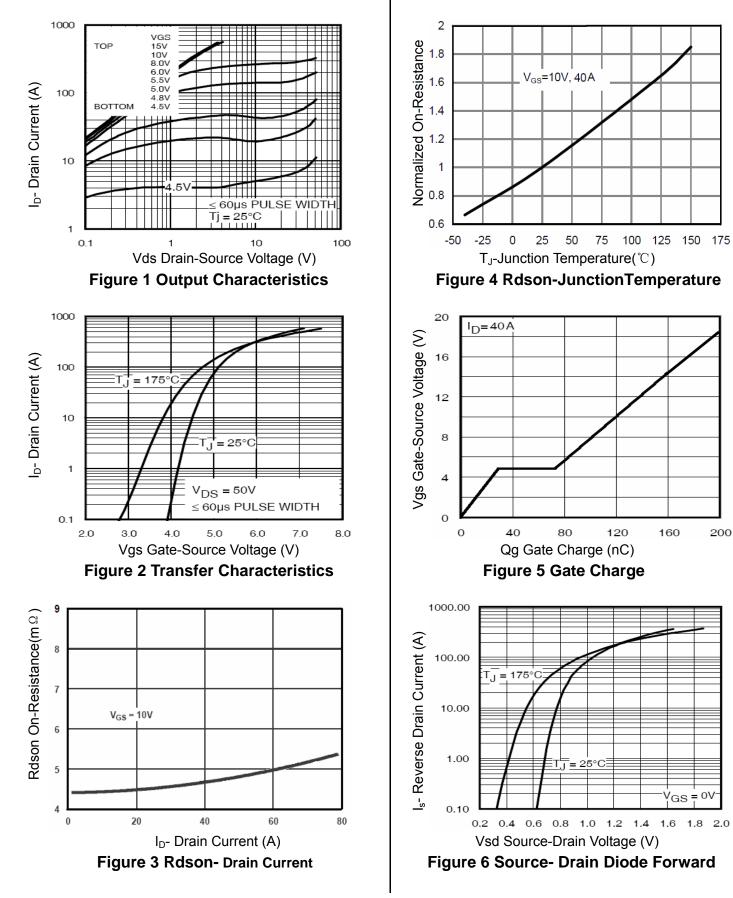
3) Switch Time Test Circuit





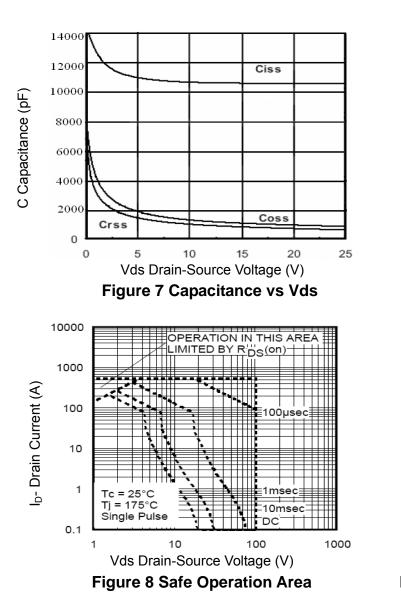


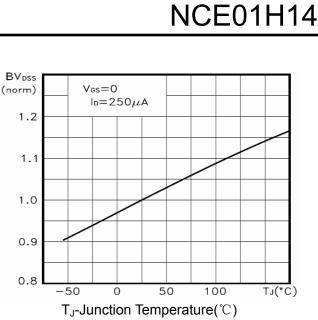
Typical Electrical and Thermal Characteristics (Curves)





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Figure 9 BV_{DSS} vs Junction Temperature

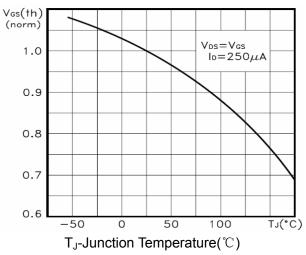
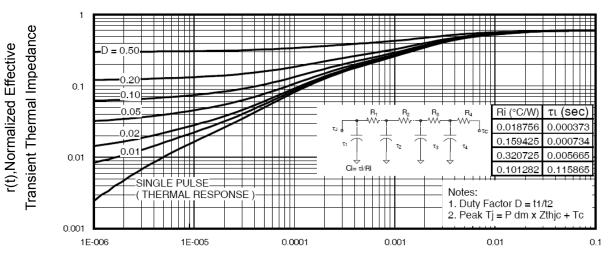


Figure 10 V_{GS(th)} vs Junction Temperature



Square Wave Pluse Duration(sec) Figure 11 Normalized Maximum Transient Thermal Impedance

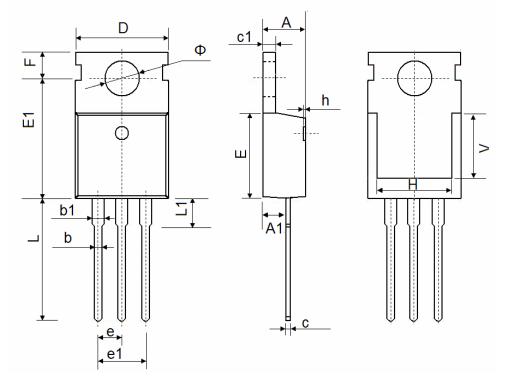


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TO-220-3L Package Information



Symbol	Dimensions	n Millimeters	Dimensions In Inches			
	Min.	Max.	Min.	Max.		
A	4.400	4.600	0.173	0.181		
A1	2.250	2.550	0.089	0.100		
b	0.710	0.910	0.028	0.036		
b1	1.170	1.370	0.046	0.054		
С	0.330	0.650	0.013	0.026		
c1	1.200	1.400	0.047	0.055		
D	9.910	10.250	0.390	0.404		
E	8.9500	9.750	0.352	0.384		
E1	12.650	12.950	0.498	0.510		
е	2.540	2.540 TYP.		0.100 TYP.		
e1	4.980	5.180	0.196	0.204		
F	2.650	2.950	0.104	0.116		
Н	7.900	8.100	0.311	0.319		
h	0.000	0.300	0.000	0.012		
L	12.900	13.400	0.508	0.528		
L1	2.850	3.250	0.112	0.128		
V	7.500 REF.		0.295 REF.			
Φ	3.400	3.800	0.134	0.150		





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